



DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS High Frequency Automotive Grade

NPO 16 V TO 50 V 0.1 pF to 100 pF

0.1 pF to 100 pF RoHS compliant & Halogen Free



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Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade 2

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<u>SCOPE</u>

This specification describes Automotive grade NPO series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AQ series soldering is compliant with J-STD-020D
- Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

NP0

GLOBAL PART NUMBER

| AQ | <u>xxxx</u> | <u>x</u> | <u>x</u> | <u>xxx</u> | <u>x</u> | В | <u>x</u> | <u>XXX</u> |
|----|-------------|----------|----------|------------|----------|---|----------|------------|
| | (1) | (2) | (3) | (4) | (5) | | (6) | (7) |

(I) SIZE - INCH BASED (METRIC)

0603 (1608)

(2) TOLERANCE

| , |
|---------------------------|
| 0.1pF |
| $B = \pm 0.1 \text{ pF}$ |
| 0.2pF to 2.0pF |
| $A = \pm 0.05 \text{ pF}$ |
| $B = \pm 0.1 \text{ pF}$ |
| $C = \pm 0.25 \text{ pF}$ |
| 2.1 pF to 5.0pF |
| $A = \pm 0.05 \text{ pF}$ |
| $B = \pm 0.1 \text{ pF}$ |
| C = ±0.25 pF |
| $D = \pm 0.5 \text{ pF}$ |
| 5.1pF to 9.9pF |
| $B = \pm 0.1 \text{ pF}$ |
| C = ±0.25 pF |
| D = ±0.5 pF |
| 10pF and over |
| $F = \pm 1\%$ |
| $G = \pm 2\%$ |
| |

- $J = \pm 5\%$
- (3) PACKING STYLE
 - R = Paper/PE taping reel; Reel 7 inch
 - P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

(5) RATED VOLTAGE

- 7 = 16 V
- 8 = 25 V
- 9 = 50 V

(6) PROCESS

N = NP0

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $|2| = |2 \times |0| = |20 \text{ pF}$



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Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

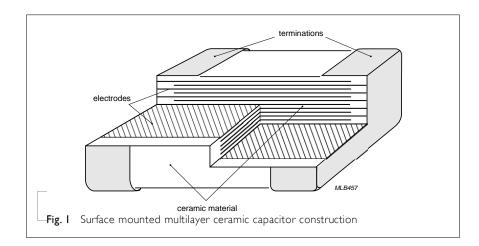
CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig.1.

DIMENSION

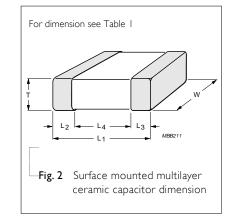
Table I For outlines see fig. 2



L₂ / L₃ (mm) L₄ (mm) W (mm) TYPE L_1 (mm) T (MM) min. max. min. 0402 1.0 ±0.05 0.5 ±0.05 0.5 ±0.05 0.15 0.35 0.40 0603 1.6 ±0.10 0.8 ±0.10 0.8 ±0.10 0.20 0.60 0.40

OUTLINES

NP0





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CAPACITANCE RANGE & THICKNESS FOR NPO

| Table 2 Sizes | 0402 to 0603 | | | | |
|---------------|--------------|---------|--------|----------|---------|
| CAP. | 0402 | 0603 | CAP. | 0402 | 0603 |
| | 50V | 50 V | | 50 V | 50 V |
| 0.1 pF | 0.5±0.05 | | 2.6 pF | 0.5±0.05 | 0.8±0.1 |
| 0.2 pF | 0.5±0.05 | 0.8±0.1 | 2.7 pF | 0.5±0.05 | 0.8±0.1 |
| 0.3 pF | 0.5±0.05 | 0.8±0.1 | 2.8 pF | 0.5±0.05 | 0.8±0.1 |
| 0.4 pF | 0.5±0.05 | 0.8±0.1 | 2.9 pF | 0.5±0.05 | 0.8±0.1 |
| 0.5 pF | 0.5±0.05 | 0.8±0.1 | 3.0 pF | 0.5±0.05 | 0.8±0.1 |
| 0.6 pF | 0.5±0.05 | 0.8±0.1 | 3.1 pF | 0.5±0.05 | 0.8±0.1 |
| 0.7 pF | 0.5±0.05 | 0.8±0.1 | 3.2 pF | 0.5±0.05 | 0.8±0.1 |
| 0.8 pF | 0.5±0.05 | 0.8±0.1 | 3.3 pF | 0.5±0.05 | 0.8±0.1 |
| 0.9 pF | 0.5±0.05 | 0.8±0.1 | 3.4 pF | 0.5±0.05 | 0.8±0.1 |
| I.0 pF | 0.5±0.05 | 0.8±0.1 | 3.5 pF | 0.5±0.05 | 0.8±0.1 |
| I.I pF | 0.5±0.05 | 0.8±0.1 | 3.6 pF | 0.5±0.05 | 0.8±0.1 |
| I.2 pF | 0.5±0.05 | 0.8±0.1 | 3.7 pF | 0.5±0.05 | 0.8±0.1 |
| 1.3 pF | 0.5±0.05 | 0.8±0.1 | 3.8 pF | 0.5±0.05 | 0.8±0.1 |
| I.4 pF | 0.5±0.05 | 0.8±0.1 | 3.9 pF | 0.5±0.05 | 0.8±0.1 |
| 1.5 pF | 0.5±0.05 | 0.8±0.1 | 4.0 pF | 0.5±0.05 | 0.8±0.1 |
| 1.6 pF | 0.5±0.05 | 0.8±0.1 | 4.1 pF | 0.5±0.05 | 0.8±0.1 |
| 1.7 pF | 0.5±0.05 | 0.8±0.1 | 4.2 pF | 0.5±0.05 | 0.8±0.1 |
| I.8 pF | 0.5±0.05 | 0.8±0.1 | 4.3 pF | 0.5±0.05 | 0.8±0.1 |
| 1.9 pF | 0.5±0.05 | 0.8±0.1 | 4.4 pF | 0.5±0.05 | 0.8±0.1 |
| 2.0 pF | 0.5±0.05 | 0.8±0.1 | 4.5 pF | 0.5±0.05 | 0.8±0.1 |
| 2.1 pF | 0.5±0.05 | 0.8±0.1 | 4.6 pF | 0.5±0.05 | 0.8±0.1 |
| 2.2 pF | 0.5±0.05 | 0.8±0.1 | 4.7 pF | 0.5±0.05 | 0.8±0.1 |
| 2.3 pF | 0.5±0.05 | 0.8±0.1 | 4.8 pF | 0.5±0.05 | 0.8±0.1 |
| 2.4 pF | 0.5±0.05 | 0.8±0.1 | 4.9 pF | 0.5±0.05 | 0.8±0.1 |
| 2.5 pF | 0.5±0.05 | 0.8±0.1 | 5.0 pF | 0.5±0.05 | 0.8±0.1 |

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I. Values in shaded cells indicate thickness class in mm

2. Capacitance value of non E-12 series is on request



0603

50 V

0.8±0.1

0.8±0.1

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CAPACITANCE RANGE & THICKNESS FOR NPO

| | Sizes 0402 | ANGE & THI 2 to 0603 | <u>en 1159</u> | 1012 | 1110 | |
|------|------------|-------------------------|----------------|------|--------|----------|
| CAP. | | 0402 | 0603 | | CAP. | 0402 |
| | | 50V | 50 V | | | 50 V |
| 5.1 | рF | 0.5±0.05 | 0.8±0.1 | | 8.2 pF | 0.5±0.05 |
| 5.2 | рF | 0.5±0.05 | 0.8±0.1 | | 8.3 pF | 0.5±0.05 |
| 5.3 | БрF | 0.5±0.05 | 0.8±0.1 | | 8.4 pF | 0.5±0.05 |
| 5.4 | рF | 0.5±0.05 | 0.8±0.1 | | 8.5 pF | 0.5±0.05 |
| 5.5 | рF | 0.5±0.05 | 0.8±0.1 | | 8.6 pF | 0.5±0.05 |
| 5.6 | рF | 0.5±0.05 | 0.8±0.1 | | 8.7 pF | 0.5±0.05 |
| 5.7 | рF | 0.5±0.05 | 0.8±0.1 | | 8.8 pF | 0.5±0.05 |
| 5.8 | врF | 0.5±0.05 | 0.8±0.1 | | 8.9 pF | 0.5±0.05 |
| 5.9 | рF | 0.5±0.05 | 0.8±0.1 | | 9.0 pF | 0.5±0.05 |
| 6.0 |) pF | 0.5±0.05 | 0.8±0.1 | | 9.1 pF | 0.5±0.05 |
| 6.1 | рF | 0.5±0.05 | 0.8±0.1 | | 9.2 pF | 0.5±0.05 |
| 6.2 | рF | 0.5±0.05 | 0.8±0.1 | | 9.3 pF | 0.5±0.05 |
| 6.3 | ЪрF | 0.5±0.05 | 0.8±0.1 | | 9.4 pF | 0.5±0.05 |
| 6.4 | рF | 0.5±0.05 | 0.8±0.1 | | 9.5 pF | 0.5±0.05 |
| 6.5 | рF | 0.5±0.05 | 0.8±0.1 | | 9.6 pF | 0.5±0.05 |
| 6.6 | рF | 0.5±0.05 | 0.8±0.1 | | 9.7 pF | 0.5±0.05 |
| 6.7 | рF | 0.5±0.05 | 0.8±0.1 | | 9.8 pF | 0.5±0.05 |
| 6.8 | врF | 0.5±0.05 | 0.8±0.1 | | 9.9 pF | 0.5±0.05 |
| 6.9 | рF | 0.5±0.05 | 0.8±0.1 | | 10 pF | 0.5±0.05 |
| 7.0 |) pF | 0.5±0.05 | 0.8±0.1 | | I2 pF | 0.5±0.05 |
| 7.1 | рF | 0.5±0.05 | 0.8±0.1 | | 15 pF | 0.5±0.05 |
| 7.2 | рF | 0.5±0.05 | 0.8±0.1 | | 18 pF | 0.5±0.05 |
| 7.3 | БрF | 0.5±0.05 | 0.8±0.1 | | 22 pF | 0.5±0.05 |
| 7.4 | рF | 0.5±0.05 | 0.8±0.1 | | 27 pF | 0.5±0.05 |
| 7.5 | рF | 0.5±0.05 | 0.8±0.1 | | 33 pF | 0.5±0.05 |
| 7.6 | рF | 0.5±0.05 | 0.8±0.1 | | 39 pF | 0.5±0.05 |
| 7.7 | рF | 0.5±0.05 | 0.8±0.1 | | 47 pF | 0.5±0.05 |
| 7.8 | ВрF | 0.5±0.05 | 0.8±0.1 | | 56 pF | 0.5±0.05 |
| 7.9 | рF | 0.5±0.05 | 0.8±0.1 | | 68 pF | 0.5±0.05 |
| 8.0 |) pF | 0.5±0.05 | 0.8±0.1 | | 82 pF | 0.5±0.05 |
| 8.1 | pF | 0.5±0.05 | 0.8±0.1 | | 100 pF | 0.5±0.05 |

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I. Values in shaded cells indicate thickness class in mm

2. Capacitance value of non E-12 series is on request



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Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

THICKNESS CLASSES AND PACKING QUANTITY

| lable 4 | | | | | | |
|---------|----------------|-------------------|------------------|---------|-------------------|---------|
| SIZE | | | Ø180 MM / 7 INCH | | Ø330 MM / 13 INCH | |
| CODE | CLASSIFICATION | QUANTITY PER REEL | Paper | Blister | Paper | Blister |
| 0402 | 0.5 ±0.05 mm | 8 mm | 10,000 | | 50,000 | |
| 0603 | 0.8 ±0.1 mm | 8 mm | 4,000 | | 15,000 | |

ELECTRICAL CHARACTERISTICS

NP0 DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

| Table 5 | |
|---------------------------------------------------------------------------------------------------|----------------------------------------------|
| DESCRIPTION | VALUE |
| Capacitance range | 0.1 pF to 100 pF |
| Capacitance tolerance | |
| NP0 C < 10 pF | ± 0.05 pF, ±0.1 pF, ±0.25 pF, ±0.5 pF |
| C ≥ 10 pF | ±1%, ±2%, ±5% |
| Dissipation factor (D.F.) | |
| NP0 C < 30 pF | ≤ / (400 + 20C) |
| C ≥ 30 pF | ≤ 0.1 % |
| Insulation resistance after 1 minute at U_r (DC) | $IR \ge 10 G\Omega$ |
| Maximum capacitance change as a function of temperature (temperature characteristic/coefficient): | |
| NP0 | ±30 ppm/°C |
| Operating temperature range: | |
| NP0 | –55 ℃ to +125 ℃ |

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SOLDERING RECOMMENDATION

| Table 6 | | | | | |
|---------------------|--------------|----------|----------|----------|-------------|
| SOLDERING METHOD | SIZE 0402 | 0603 | 0805 | 1206 | ≥ 1210 |
| Reflow | ≥0.1 µF | ≥ 1.0 µF | ≥ 2.2 µF | ≥ 4.7 µF | Reflow only |
| Reflow/Wave | < 0.1 µF | < 1.0 µF | < 2.2 µF | < 4.7 µF | |

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

TESTS AND REQUIREMENTS

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

Table 7 Test procedures and requirements

| TEST | TEST METHOD | | PROCEDURE | REQUIREMENTS | | |
|------------------------------|-------------------------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|--|--|
| Mounting | IEC 60384- 4.3 21/22 | | The capacitors may be mounted on printed-circuit boards or ceramic substrates | No visible damage | | |
| Capacitance | IEC 60384- 21/22 | 4.5.1 | Class I: At 20 °C, 24 hours after annealing $f = I MHz$ for $C \le InF$, measuring at voltage I V _{rms} at 20 °C f = I KHz for $C > InF$, measuring at voltage I V _{rms} at 20 °C | Within specified tolerance | | |
| Dissipation Factor (D.F.) | IEC 60384- 21/22 | 4.5.2 | Class I: At 20 °C, 24 hours after annealing $f = I MHz$ for $C \le InF$, measuring at voltage I V _{rms} at 20 °C f = I KHz for $C > InF$, measuring at voltage I V _{rms} at 20 °C | In accordance with specification | | |
| Insulation Resistance | IEC 60384- 21/22 | 4.5.3 | At U _r (DC) for I minute | In accordance with specification | | |

| | TEST METH | | PROCEDURE | REQUIREMENTS | | | |
|---------------------------------|-----------|---|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------|--|--|--|
| Temperature coefficient | 4.6 | | PROCEDURECapacitance shall be measured by the steps shown in the following table.The capacitance change should be measured after 5 min at each specified temperature stage.Step Temperature(°C)a25±2bLower temperature±3°Cc25±2dUpper Temperature±2°Ce25±2(1) Class ITemperature Coefficient shall be calculated from the formula as belowTemp, Coefficient = $\frac{C2 - CI}{CI \times \Delta T} \times 10^6$ [ppm/°C]Cl: Capacitance at step cC2: Capacitance at step c(2) Class IICapacitance Change shall be calculated from the | <general purpose="" series=""> Class I: Δ C/C: ±30ppm</general> | | | |
| High Temperature Exposure | AEC-Q200 | 3 | Unpowered ; 1000hours @ T=150° C Measurement at 24±2 hours after test conclusion. | No visual damage Δ C/C : Class I : NP0: within ±0.5% or 0.5 pF whichever is greater | | | |
| Temperature Cycling | AEC-Q200 | 4 | Preconditioning: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours | No visual damage $\Delta C/C$ Class I: NP0: Within ±1% or 0.5pF, whichever is greater. D.F. meet initial specified value | | | |

Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

Product specification

NP0

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| TEST TEST ME | | HOD | PROCEDURE | REQUIREMENTS | | |
|------------------------|---------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| Moisture Resistance | AEC-Q200 | 6 | T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 \pm 2 hours after test condition. | No visual damage | | |
| | | | | $\Delta C/C$ NP0: Within ±3% or 3 pF, whichever is greater | | |
| | | | | D.F. Within initial specified value IR NP0: \geq 10,000 M Ω | | |
| | ure resistant | 60 A 55 - 50 - 50 - 40 - 40 - 33 - 25 - 20 - 10 - 5 - -5 - -10 - | | | | |
| Biased Humidity | AEC-Q200 | 7 | Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U_r for 1,000 hours. Recovery: Class1: 6 to 24 hours Class2: 24 ±2 hours | No visual damage after recovery Initial requirement: Class I: - Connected to 100 K Ω : C \leq 10 nF: I.R \geq 10,000 M Ω or C \geq 10 nF: (I.R-100 K Ω) \times C \geq 100: Final measurement: The insulation resistance shall be greater than 0.1 time initial value. | | |

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TEST TEST METHOD PROCEDURE REQUIREMENTS **Operational Life** AEC-Q200 8 No visual damage I. Initial measure: Spec: refer to initial spec C, D, IR $\Delta C/C$ 2. Endurance test: NPO: Within ±2% or 1 pF, whichever Specified stress voltage applied for 1,000 hours: is greater Applied 2.0 \times U_r for general products D.F. 3. Recovery time: 24 ±2 hours NP0: $\leq 2 \times$ specified value. 4. Final measure: C, D, IR Note: If the capacitance value is less than the minimum NP0: \geq 4,000 M Ω or IR \times C_r \geq 40s value permitted, then after the other measurements whichever is less have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met. **External Visual** AEC-Q200 9 Any applicable method using × 10 magnification In accordance with specification Physical AEC-Q200 10 Verify physical dimensions to the applicable device In accordance with specification Dimension specification. Mechanical AEC-Q200 13 $\Delta C/C$ Three shocks in each direction shall be applied along Shock NP0: Within ±0.5% or 0.5 pF, the three mutually perpendicular axes of the test whichever is greater specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms DF Velocity change: 15.4 ft/s Within initial specified value Waveform: Half-sin IR Within initial specified value Vibration AEC-Q200 14 $\Lambda C/C$ 5 g's for 20 minutes, 12 cycles each of 3 orientations. NP0: Within ±0.5% or 0.5 pF, Note: whichever is greater Use 8" x 5" PCB. 0.31" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. D.F: meet initial specified value Test from 10-2000 Hz. IR meet initial specified value Resistance to AEC-Q200 15 Precondition: 150 +0/-10 °C for 1 hour, then keep for Dissolution of the end face plating Soldering Heat 24 ±1 hours at room temperature shall not exceed 25% of the length of the edge concerned Preheating: for size ≤ 1206: 120 °C to 150 °C for 1 minute $\Delta C/C$ Preheating: for size >1206: 100 °C to 120 °C for 1 Class I: minute and 170 °C to 200 °C for 1 minute NPO: Within ±1% or 0.5 pF, Solder bath temperature: 260 ±5 °C whichever is greater. Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours D.F. within initial specified value IR within initial specified value

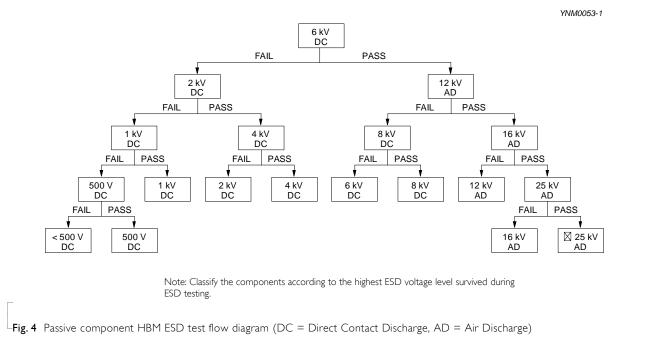
Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

Product specification 11 16 V to 50 V

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| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS | | |
|---------------|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------|--|--|
| Thermal Shock | AEC-Q200 16 | Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp Initial measure: Spec: refer to initial spec C, D, IR Rapid change of temperature test: | No visual damage $\Delta C/C$ NP0: Within ±1% or 1 pF, whichever is greater | | |
| | | NP0: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature. 4. Recovery time: Class1: 6 to 24 hours Class2: 24 ±2 hours 5. Final measure: C, D, IR | D.F: meet initial specified value IR meet initial specified value | | |
| ESD | AEC-Q200 17 | Per AEC-Q200-002 | A component passes a voltage level if all components stressed at that voltage level pass. | | |
| | | FAIL PASS | YNM0053-1 | | |



Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade NP0

| TEST | TEST METH | IOD | PROCEDURE | REQUIREMENTS | | | | |
|--------------------------------|-------------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|-------|--------|------|--|
| Solderability | AEC-Q200 | 18 | Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds. | The solder should cover over 95% of the critical area of each termination. | | | | |
| | | | Test conditions for lead containing solder alloy Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: 1 | | | | | |
| | | | Test conditions for lead-free containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305 Number of immersions: 1 | | | | | |
| Electrical Characterization | AEC-Q200 | 19 | Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures. | ΔC/C Class 1: NP0: ±30 ppm/°C | | | | |
| | | | Class 1: NP0: -55 °C to +125 °C Normal temperature: 20 °C | | | | | |
| Board Flex | AEC-Q200 21 | | Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 μm ± 10 μm. Part should be mounted using the following soldering reflow profile. Conditions: Class 1: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm | 0 | | | | |
| | | | Test Substrate: | | Dimen | sion(m | m) | |
| | | | <mark> ↔ </mark> | Туре | а | b | с | |
| | | | | 0201 | 0.3 | 0.9 | 0.3 | |
| | | | | 0402 | 0.4 | 1.5 | 0.5 | |
| | | | | 0603 | 1.0 | 3.0 | 1.2 | |
| | | | | 0805 | 1.2 | 4.0 | 1.65 | |
| | | | 100 | 1206 | 2.2 | 5.0 | 1.65 | |
| | | | l ∢ unit: mm | 1210 | 2.2 | 5.0 | 2.0 | |
| | | | unit. mm | 1808 | 3.5 | 7.0 | 3.7 | |

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Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade NP0 16

Product specification 13 16 V to 50 V

| TEST | TEST METHOD | | PROCEDURE | REQUIREMENTS |
|----------------------|-------------|----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Terminal Strength | AEC-Q200 | 22 | With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size. | Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before, during and after the test, the device shall comply with all electrical requirements stated in this specification. |
| Beam Load Test | AEC-Q200 | 23 | Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained. | ≤ 0805 Thickness > 0.5mm: 20N Thickness ≤ 0.5mm: 8N ≥ 1206 Thickness ≥1.25 mm: 54N Thickness < 1.25 mm: 15N |
| Voltage Proof | | | Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur 100 V < Ur ≤ 200 V series applied (1.5 Ur + 100) 200 V < Ur ≤ 500 V series applied (1.3 Ur + 100) Ur > 500 V: 1.3 Ur Ur ≥ 1000 V: 1.2 Ur Charge/Discharge current is less than 50 mA | No breakdown or flashover |
| ESR | | | Measuring frequency: 1 ± 0.2 GHz at room temperature. | $0.1 \text{pF} \leq C \leq 1 \text{pF} : 350 \text{m}\Omega / C \text{max}$ $1 \text{pF} < C \leq 5 \text{pF} : 300 \text{m}\Omega \text{max}$ $5 \text{pF} < C \leq 10 \text{pF} : 250 \text{m}\Omega \text{max}$ C : Nominal cap (pF) |
| - | | | Measuring frequency: 500 \pm 50MHz at room temperature. | $10pF < C \leq 100pF$:400m Ω max |

| YAGEO | 1 | | Product specification | 14 |
|--------------|---|------------------------------------|-----------------------|----|
| | | gh Frequency tomotive grade NP0 | 16 V to 50 V | 15 |

<u>REVISION HISTORY</u>

| REVISION | DATE | CHANGE NOTIFICATION | DESCRIPTION |
|-----------|---------------|---------------------|---------------------------|
| Version I | Feb. 08, 2021 | - | - Add 0402 / 0.1 pf~100pF |
| Version 0 | Dec. 14, 2018 | - | - New |

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